

WISOL / WSSF10R3AT

DATA SHEET Rev.00



WISOL

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1. Scope

Description : Sigfox Module RC3

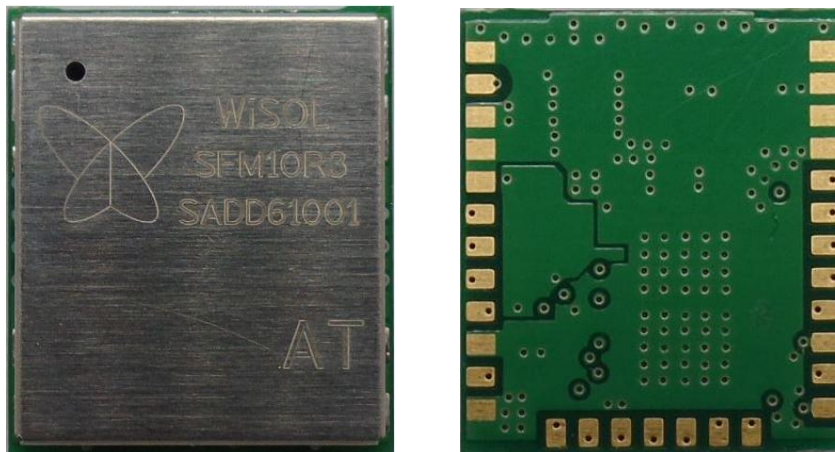
Type : SMD Type

PCBA Size : 13mm(W) x 15mm(L) x 2.21mm(H)

This module is SIGFOX verified and that the TELEC are ongoing. TELEC test result will be update.

2. Numbering of product

2-1. Product



2-2. Part No.

W	S	S	F	M	1	0	R	3	A	T
(1)	(2)	(3)	(4)	(5)	(6)	(7)	(8)	(9)	(10)	(11)

No.	EXPLANATION
(1),(2)	WISOL
(3),(4)	Application (SF:Sigfox)
(5)	Type (M:Module)
(6),(7)	Group model numbering
(8), (9)	Region Code(R3:Japan)
(10),(11)	Application Type(Firm Ware Type) AT(AT command version) AP(API version)

3. Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
VCC	Module input voltage	-0.5 to 5.5	V
OT	Operating Temperature	-30 to +85	°C
ST	Storage Temperature	-40 to +125	°C

4. DC Characteristics

Symbol	Parameter	Min	Typ.	Max	Unit
VCC	Module input voltage	2.0	3.3	3.6	V
Current	Tx Current(@”15”setting,MOD)	-	65	-	mA
	Tx Current(@”14”setting,MOD)		54	-	mA
	Rx Current	-	15	-	mA
	Sleep Current		2	-	uA

5. I/O Specifications

Symbol	Parameter	Min	Typ.	Max	Unit
VIH	High level input voltage @VCC=3.3V	2.0			V
VIL	Low level input voltage @CC=3.3V			0.8	V

6. RF Specifications

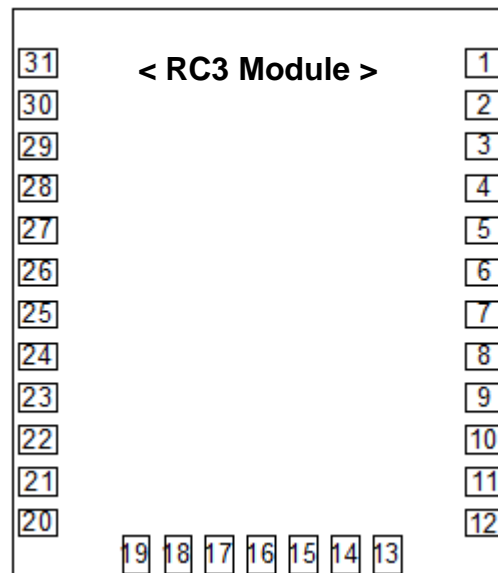
Conditions: VCC=3.3V, Temp=25°C

Parameter		Min	Typ.	Max	Unit
RF Characteristics					
RF Frequency	Tx		923.2		MHz
	Rx		922.2		MHz
Tx output power(at "15" setting)			13.5		dBm
Tx output power(at "14" setting)			12.5		dBm
Frequency Error Tolerance(+25°C)		-2.5	-	+2.5	ppm
2 nd Harmonics(conducted)		-	-37	-35	dBm
3 rd Harmonics(conducted)		-	-41	-35	dBm
Rx Sensitivity(@600bps, GFSK)		-	-127	-	dBm
Rx Spurious Emission(30MHz~12.75GHz)				-54	dBm

* Because of output power variation of modules the maximum output power can be over 14dBm, so we recommend to set 14 as default output setting.

7. Pin Description

7-1. Interface PIN(SMD Type : 31 Pin)_Bottom view



1	GND	9	GPIO5	17	TXLED/ DBG_CLK	25	GPIO2
2	GND	10	GPIO4	18	NC4/DBG_EN	26	GPIO3
3	GND	11	CPU_LED	19	RST_N	27	GND
4	GND	12	RADIO_LED	20	GND	28	GND
5	NC3/ SYSCLK	13	GPIO9	21	VDD_IO	29	GND
6	GPIO8	14	UARTTX	22	GND	30	RF_IO
7	GPIO7	15	UARTRX	23	GPIO0	31	GND
8	GPIO6	16	RXLED/ DBG_DATA	24	GPIO1		

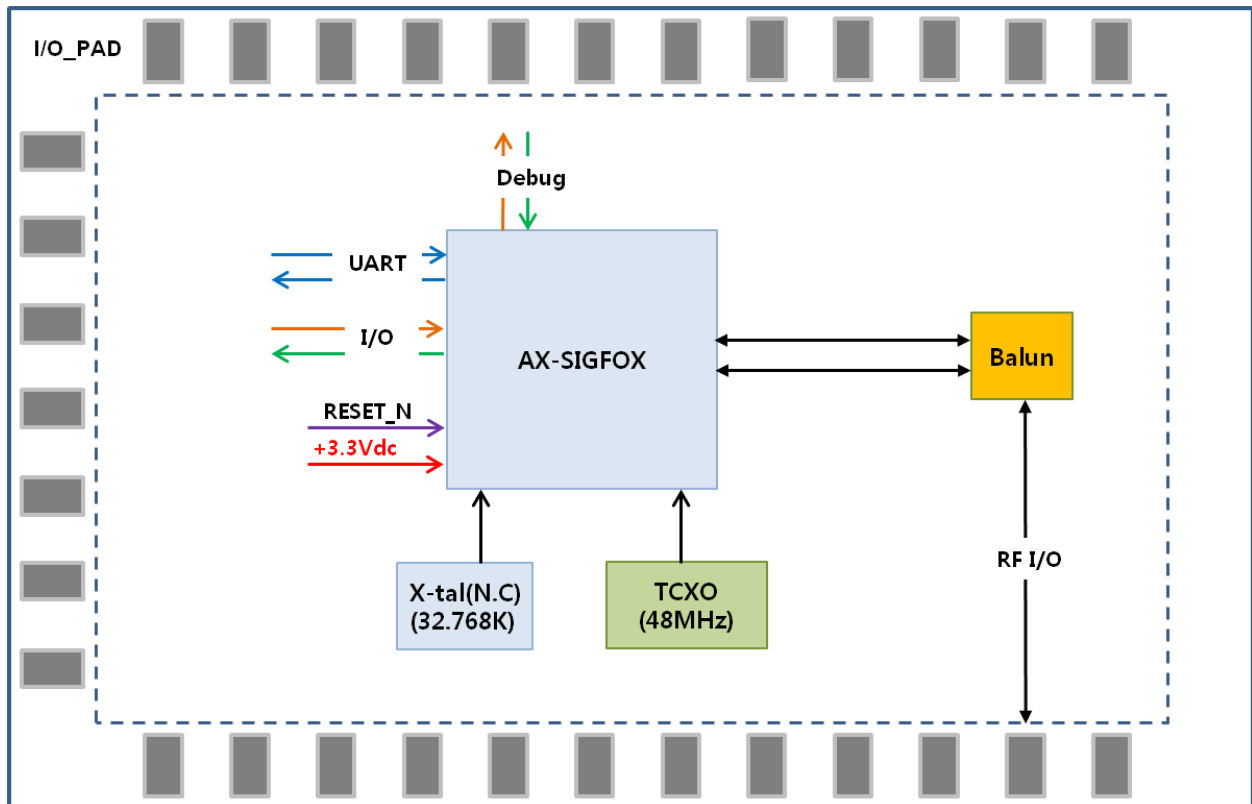
Pin-map of RC1, RC2, RC3 and RC4 module is compatible (Pin to Pin)

7-2. Interface PIN description

PIN(s)	NAME	TYPE	Description
1~4	GND	P	Ground
5	NC3/SYSCLK	N	Do not connect
6	GPIO8	I/O/PU	General purpose IO
7	GPIO7	I/O/PU	General purpose IO, selectable SPI functionality (MISO)
8	GPIO6	I/O/PU	General purpose IO, selectable SPI functionality (MOSI)
9	GPIO5	I/O/PU	General purpose IO, selectable SPI functionality (SCK)
10	GPIO4	I/O/PU	General purpose IO, selectable $\Sigma\Delta$ DAC functionality, selectable dock functionality
11	CPU_LED	O	CPU activity indicator
12	RADIO_LED	O	Radio activity indicator
13	GPIO9	I/O/PU	General purpose IO, wakeup from deep sleep
14	UARTTX	O	UART transmit
15	UARTRX	I/PU	UART receive
16	RXLED/DBG_DATA	O	Receive activity indicator
17	TXLED/DBG_CLK	O	Transmit activity indicator
18	NC4/DBG_EN	PD	Do not connect
19	RST_N	I/PU	Optional reset pin
20	GND	P	Ground
21	VDD_IO	P	Power supply
22	GND	P	Ground
23	GPIO0	I/O/A/PU	General purpose IO, selectable ADC functionality, selectable $\Sigma\Delta$ DAC functionality, selectable clock functionality
24	GPIO1	I/O/A/PU	General purpose IO, selectable ADC functionality
25	GPIO2*	I/O/A/PU	General purpose IO, selectable ADC functionality
26	GPIO3*	I/O/A/PU	General purpose IO, selectable ADC functionality
27	GND	P	Ground
28~29	GND	P	Ground
30	RF_IO	A	RF input/output
31	GND	P	Ground

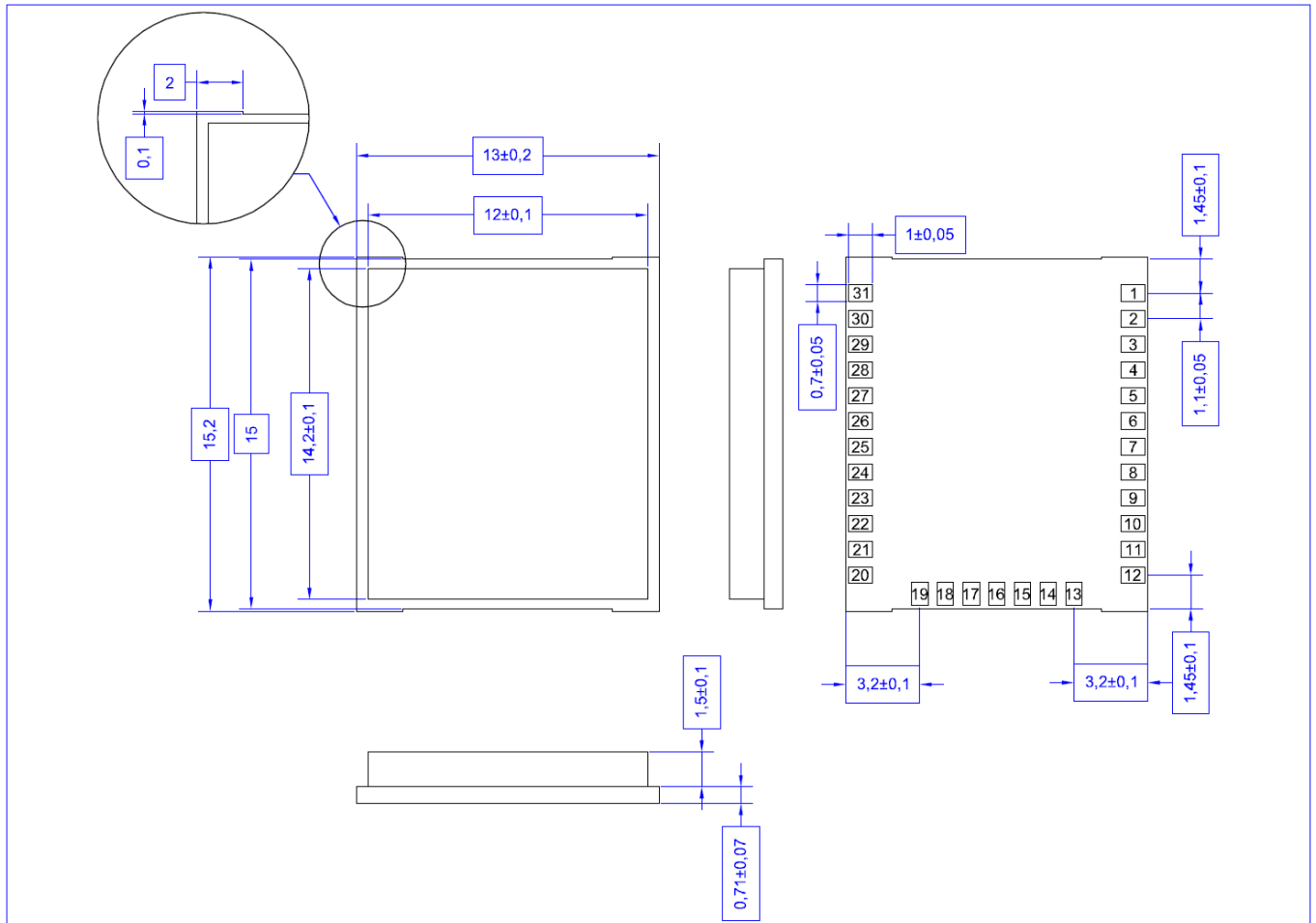
* The GPIO2 and GPIO3 pin as "Not connected" state if the product is designed to be compatible with RCZ2 and RCZ4 module.

8. Block Diagram

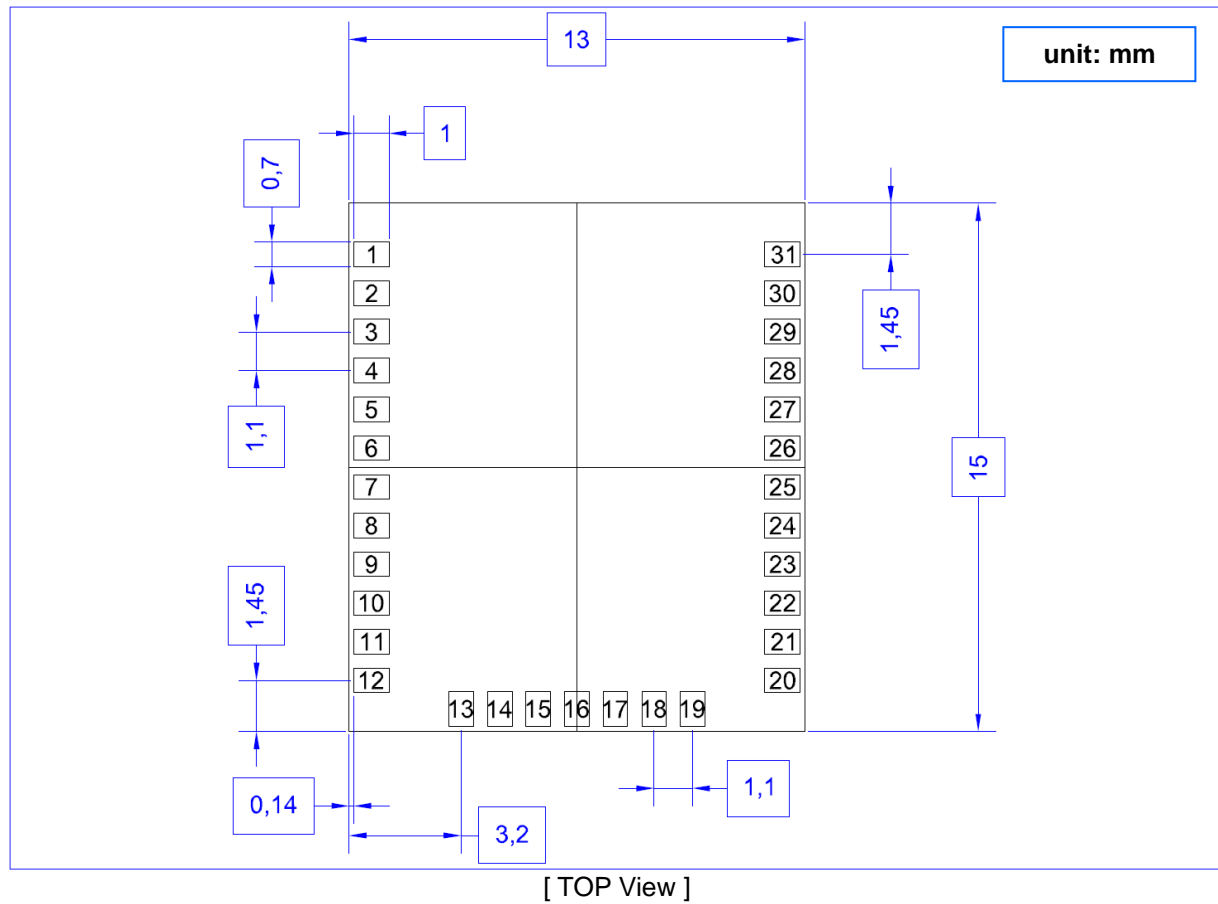


9. Dimensions & drawing

9-1. Design dimension

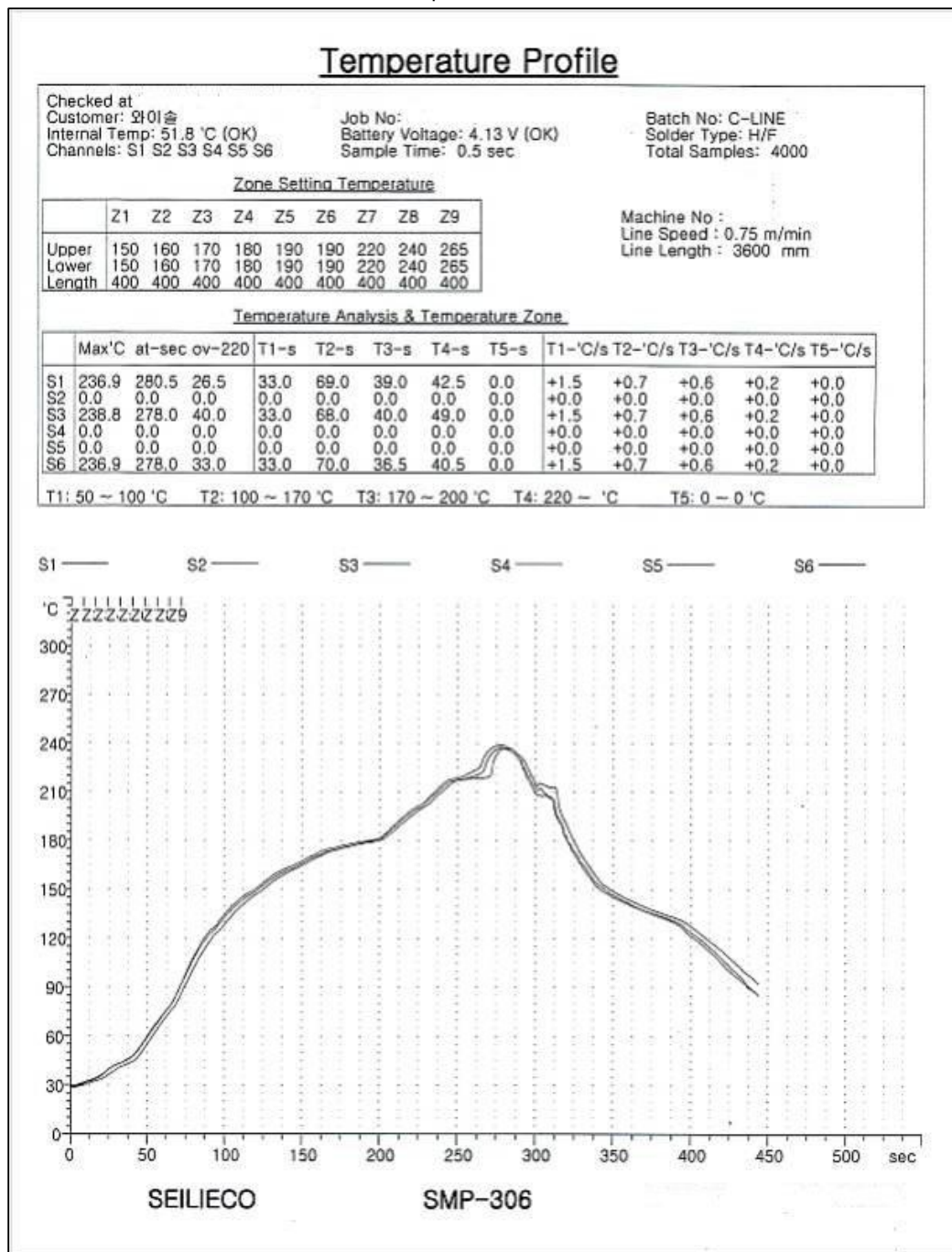


9-2. Soldering Footprint



10. Reflow profile

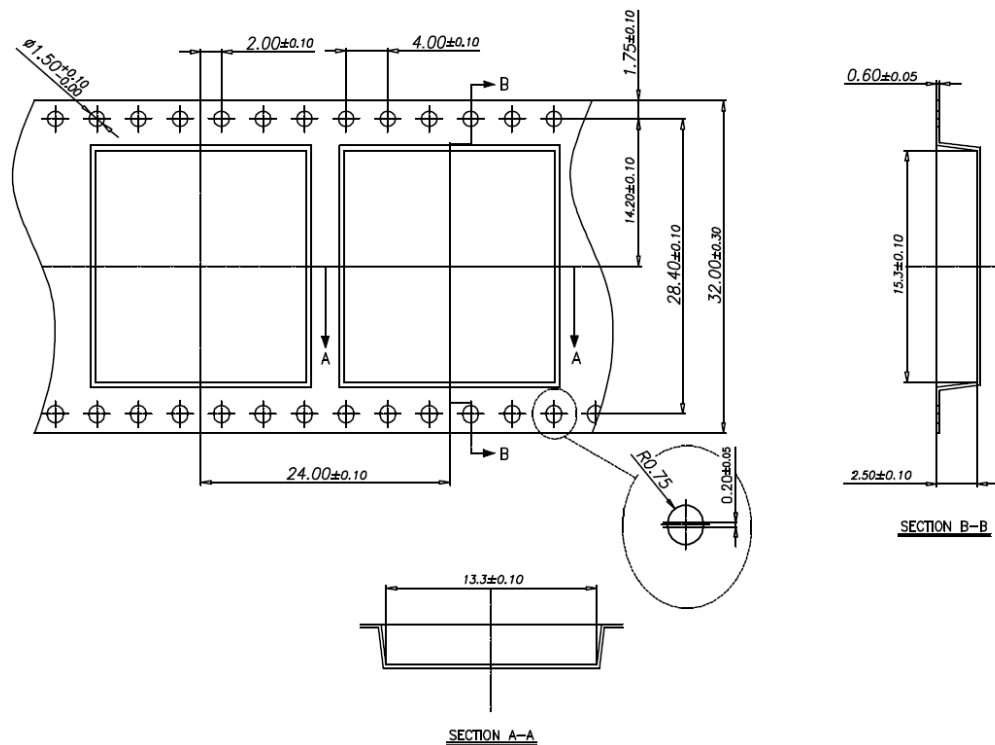
<Reflow profile of Module>



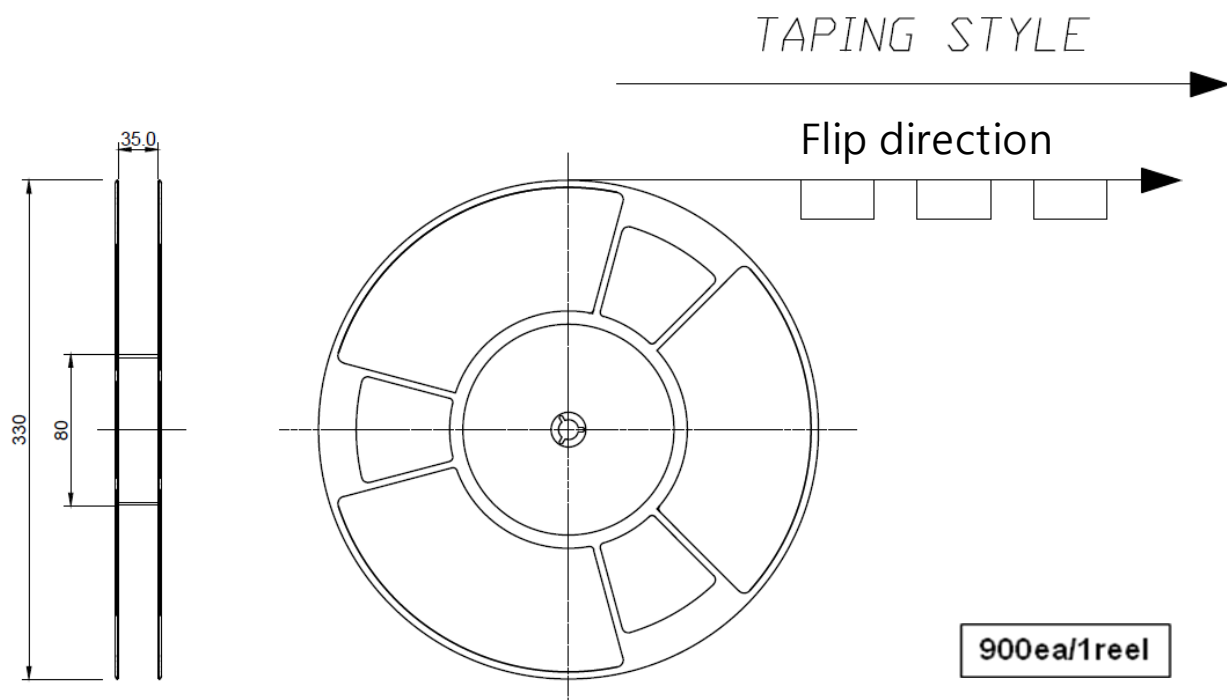
SPEC	Preheat	Soak	Ramp	PEAK
	50~100°C	100~170°C	220°C ↑	240°C
	1~2°C/sec	60~100sec	30~50sec	±5°C
result of measurement	1.5	69	44	237.5
	OK	OK	OK	OK

11. Package

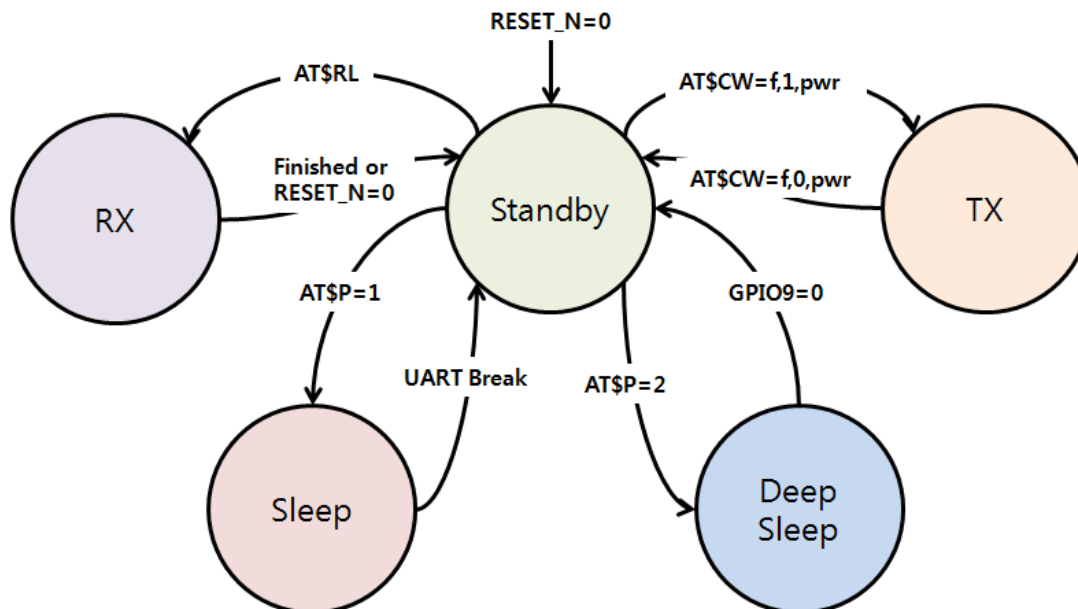
11-1. Dimension of Tape



11-2. Dimension of Reel



12. Power Modes



12-1. TX current test

1. Disconnect Debug Switch(SW5~SW9) on EVB
2. Connect UART Switch(SW10~SW11) on EVB
3. Power switch ON(SW4) on EVB
4. Push the RESET Switch(SW1) on EVB
5. Initial mode=Standby mode (@500uA/ Remove J2-CPULED jumper)
6. TX current test method
 - 1) Input AT command 'AT' (UART condition checking)
 - 2) Click the Quick command (: default power table '15') or Input AT command 'AT\$IF=923200000 click 'Send' icon, then 'ATS302=15', click 'Send' icon, 'AT\$CB=-1,1' and then click 'Send' icon.
For changing RF power, use 'ATS302=XX' and then click 'Send' icon instead of using 'ATS302=15'
 - 3) Disconnect UART Switch(SW10~SW11) on EVB
 - 4) And then, Check TX current

12-2. RX current test

1. Disconnect Debug Switch(SW5~SW9) on EVB
2. Connect UART Switch(SW10~SW11) on EVB
3. Power switch ON(SW4) on EVB
4. Push the RESET Switch(SW1) on EVB
5. Initial mode=Standby mode (@500uA/ Remove J4-CPULED jumper)
3. RX current test method
 - 1) Input AT command 'AT' (UART condition checking)
 - 2) Input AT command 'AT\$RSL' and then click 'Send' icon.
 - 3) Disconnect UART Switch(SW10~SW11) on EVB
 - 4) And then, Check TX current.

12-3. Sleep current test

1. Disconnect Debug Switch(SW5~SW9) on EVB
2. Connect UART Switch(SW10~SW11) on EVB
3. Power switch ON(SW4) on EVB
4. Push the RESET Switch(SW1) on EVB
5. Initial mode=idle mode (@500uA/ Remove J2-CPULED jumper)
6. Sleep current test method
 - 1) Input AT command 'AT' (UART condition checking)
 - 2) Input AT command 'AT\$P=1' (sleep mode command)
 - 3) Disconnect UART Switch(SW10~SW11) on EVB
 - 4) And then, Check Sleep current

12-4. Deep sleep current test

1. Disconnect Debug Switch(SW5~SW9) on EVB
2. Connect UART Switch(SW10~SW11) on EVB
3. Power switch ON(SW4) on EVB
4. Push the RESET Switch(SW1) on EVB
5. Initial mode=idle mode (@500uA/ Remove J2-CPULED jumper)
6. Sleep current test method
 - 1) Input AT command 'AT' (UART condition checking)
 - 2) Input AT command 'AT\$P=1' (sleep mode command)
 - 3) Disconnect UART Switch(SW10~SW11) on EVB
 - 4) And then, Check Sleep current
 - 5) If the module wakes up, Push the tact switch(SW2: wakeup PIN) on EVB